DIOTEC ELECTRONICS CORP 18020 Hobart Blvd., Unit B Gardena, CA 90248 U.S.A

Tel.: (310) 767-1052 Fax: (310) 767-7958

50 AMP PRESS FIT HIGH VOLTAGE DIODES (GPP DIE)

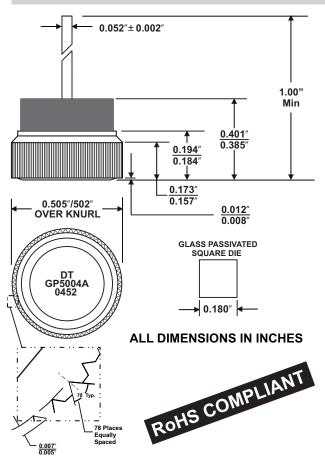
FEATURES

- VOID FREE VACUUM DIE SOLDERING For Maximum Mechanical Strength And Heat Dissipation (Solder Voids: Typical ≥ 2%, Max. ≥ 5% of Die Area)
- Full Silicon Die Area on P- and N-Sides Are Soldered to Copper Slugs For Minimum Stress And Maximum Heat Dissipation
- Press Fit Into Heat Sink to Further Enhance Heat Handling Capability
- Very Low Resistivity Silicon Die For Lower Operating Junction Temperature
- Very Low Reverse Current Leakage For Minimum Energy Loss

MECHANICAL DATA

- Case: Nickel plated copper
- Finish: All external surfaces are corrosion resistant and the contact areas are readily weldable or solderable
- Maximum Soldering Temperature: 250 °C, 0.25" from case for 10 Seconds
- Mounting Position: Any. Maximum force used for diode insertion to be 12 KN
- Polarity: Color coded epoxy ring-ANODE on LEAD (Beige Ring): Part No.=GP5002PFA/GP5004PFA. CATHODE on LEAD (Black Ring) Part No.=GP5002PFC/GP5004PFC. Part No. marked on cap base.

MECHANICAL SPECIFICATION



MAXIMUM RATINGS & ELECTRICAL CHARACTERISTICS

Ratings at 25 °C ambient temperature unless otherwise specified.

PARAMETER (TEST CONDITIONS)		SYMBOL	RATINGS		UNITS	
Series Number			GP5002PFA GP5002PFC	GP5004PFA GP5004PFC		
Maximum Recurrent Peak Reverse V	oltage	VRRM				
Working Peak Reverse Voltage		VRWM	200	400		
Maximum DC Blocking Voltage		V DC			VOLTS	
Non-Repetitive Peak Reverse Voltage	e (Half Wave, 60 Hz, Single Phase)	Vrsm	240	480		
Average Forward Rectified Current		lo	50	50		
Non-repetitive Peak Forward Surge ((Half wave, single phase, 60 Hz sine		lfsm	600	600	AMPS	
Forward VoltageDrop	@ 50Amp DC (Typical) @ 100Amp DC (Typical)	VF	<1.05 <1.20	<1.05 <1.20	VOLTS	
Maximum DC Reverse Current at Rated Blocking Voltage Tc = 25 °C)		lR	<1.0	<1.0	μ Α	
Junction Operating & Storage Temperature Range		ТJ,Тsтg	-65 to +200	-65 to +200	°C	